



**SPECIFICATION
FOR
LCM Module
KD022QVFBD014**

MODULE:	KD022QVFBD014
CUSTOMER:	

REV	DESCRIPTION	DATE
1.0	FIRST ISSUE	2019.04.11
1.1	Update drawing &4.1	2019.06.04

STARTEK	INITIAL	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

CUSTOMER	INITIAL	DATE
APPROVED BY		

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常备库存
Stock For Sale

长期供货
Long Time supply

支持小量
NO MOQ

品种齐全
In Full Range



Revision History

Date	Rev. No.	Page	Summary
2019.04.11	V1.0	ALL	FIRST ISSUE
2019.06.04	V1.1	8	Update drawing &4.1

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*** Description**

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 2.2'TFT-LCD contains 240X320 pixels, and can display up to 65K colors.

*** Features**

- Low Input Voltage: 3.3V(TYP)
- Display Colors of TFT LCD: 65K colors
- Interface: 8/16Bit MCU Interface

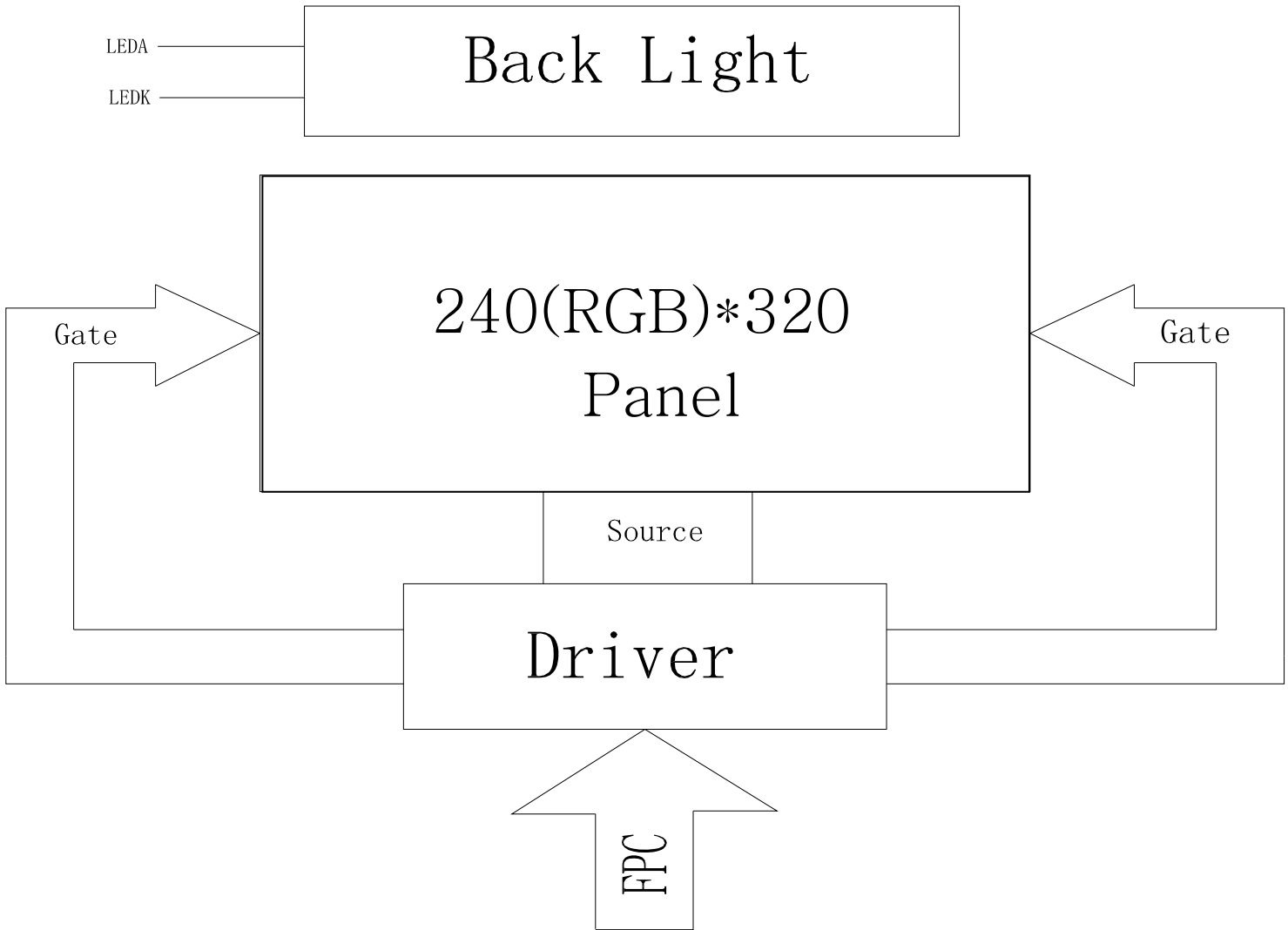
General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	33.84(H) *45.12(V) (2.2inch)	mm	-
Driver element	TFT active matrix	-	-
Display colors	65K	colors	-
Number of pixels	240(RGB)*320	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0.141 (H) x 0.141 (V)	mm	-
Viewing angle	ALL	o'clock	-
TFT Controller IC	R61516	-	-
Display mode	Normally Black	-	-
Operating temperature	-20~+70	°C	-
Storage temperature	-30~+80	°C	-

*** Mechanical Informations**

Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)		41.70		mm	-
	Vertical(V)		56.16		mm	-
	Depth(D)		--	2.6	mm	-
Weight			TBD		g	-



1. Block Diagram

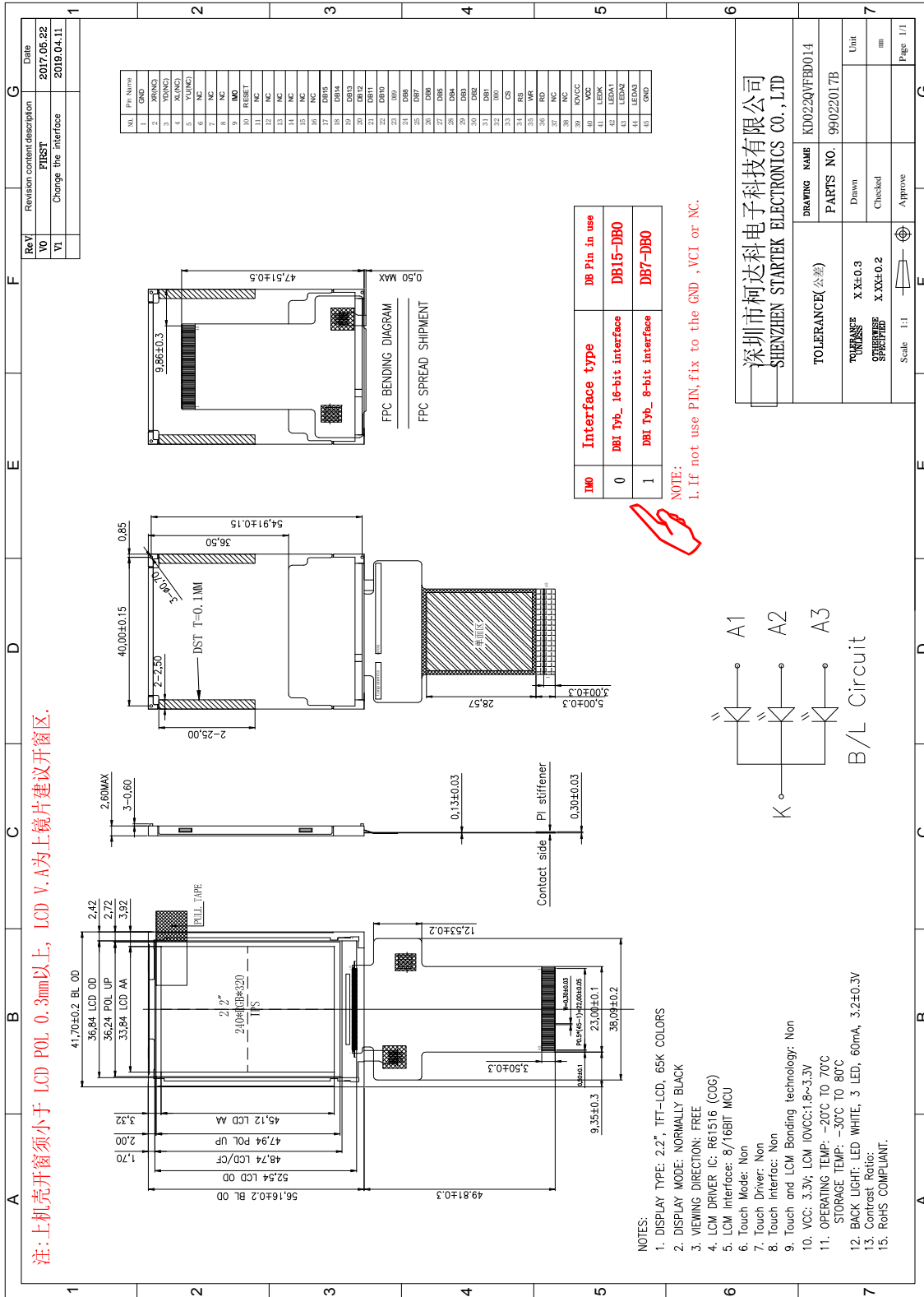


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2. Outline dimension



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3. Input terminal Pin Assignment

NO.	SYMBOL	DISCRIPTION	I/O									
1	GND	Ground.	P									
2	XR(NC)	Touch panel Right Glass Terminal	A/D									
3	YD(NC)	Touch panel Bottom Film Terminal	A/D									
4	XL(NC)	Touch panel LEFT Glass Terminal	A/D									
5	YU(NC)	Touch panel Top Film Terminal	A/D									
6	NC											
7	NC											
8	NC											
9	IMO	<p>Interface select signal.</p> <table border="1"> <thead> <tr> <th>IMO</th> <th>Interface type</th> <th>DB Pin in use</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>DBI Tyb_ 16-bit interface</td> <td>DB15-DB0</td> </tr> <tr> <td>1</td> <td>DBI Tyb_ 8-bit interface</td> <td>DB7-DB0</td> </tr> </tbody> </table>	IMO	Interface type	DB Pin in use	0	DBI Tyb_ 16-bit interface	DB15-DB0	1	DBI Tyb_ 8-bit interface	DB7-DB0	I
IMO	Interface type	DB Pin in use										
0	DBI Tyb_ 16-bit interface	DB15-DB0										
1	DBI Tyb_ 8-bit interface	DB7-DB0										
10	RESET	Reset pin. The R61516 is initialized when RESX is Low. Make sure to execute power-on reset when turning the power supply on.	I									
11-16	NC											
17-32	DB15-DB0	16-bit bi-directional data bus in DBI Type B operation.	I/O									
33	CS	<p>Chip select signal.</p> <p>Low: Select (Accessible)</p> <p>High: Not select (Inaccessible)</p> <p>Make sure to connect to host processor. Follow AC timing to control the signal.</p>	I									
34	RS	<p>Command/data select signal</p> <p>Low: Select command</p> <p>High: Select data</p>	I									
35	WR	<p>Write strobe signal in DBI Type B operation.</p> <p>Write data when WRX is Low.</p>	I									

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36	RD	Read strobe signal. Read out data when RDX is Low.	I
37-38	NC		
39	IOVCC	Supply voltage(1.65-3.3V).	P
40	VCC	Supply voltage(3.3V).	P
41	LEDK	Cathode pin OF backlight	P
42	LEDA1	Anode pin of backlight	P
43	LEDA2	Anode pin of backlight	P
44	LEDA3	Anode pin of backlight	P
45	GND	Ground.	P

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4. LCD Optical Characteristics

4.1 Optical specification

Item	Symbol	Condition	Min.	Typ.	Max.	Unit.	Note
Contrast Ratio	CR	$\Theta=0$	--	500	--		
Response time	Rising	Normal viewing angle	--	35	50	msec	Fig.3
	Falling						
Color gamut	S(%)			75		%	
Color Filter Chromaticity	White	W_x	0.287	0.327	0.367		
		W_y	0.317	0.357	0.397		
	Red	R_x	0.611	0.631	0.651		
		R_y	0.318	0.338	0.358		
	Green	G_x	0.313	0.333	0.353		
		G_y	0.595	0.615	0.635		
	Blue	B_x	0.13	0.15	0.17		
		B_y	0.024	0.044	0.064		
Viewing angle	Hor.	XL		80	--		C/R>10 Fig.4
		XR		80	--		
	Ver.	YU		80	--		
		YD		80	--		
Option View Direction	Free						

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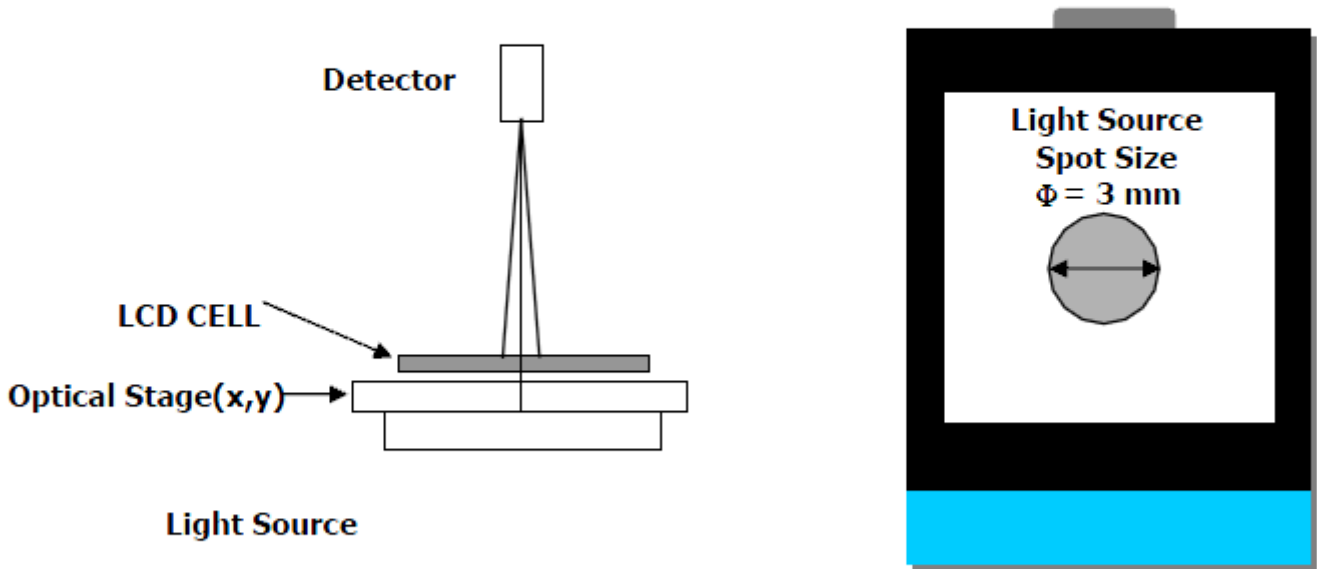
Notes : 1. Contrast Ratio(CR) is defined mathematically as :

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

2. Surface luminance is the center point across the TFT-LCD surface 500 mm from the surface with all pixels displaying white. For more information see FIG 1.
3. Response time is the time required for the display to transition from white to black(Rise Time, Tr) and from black to white(Falling Time, Tf). For additional information see FIG 3.
4. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the TFT-LCD surface. For more information see FIG 4.
5. Optimum contrast is obtained by adjusting the TFT-LCD Threshold voltage(Vth & Vsat)

FIG. 1 Optical Characteristic Measurement Equipment and Method

DMS 803 System



<Transmissive Mode>

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FIG. 2 The definition of Vth and Vsat

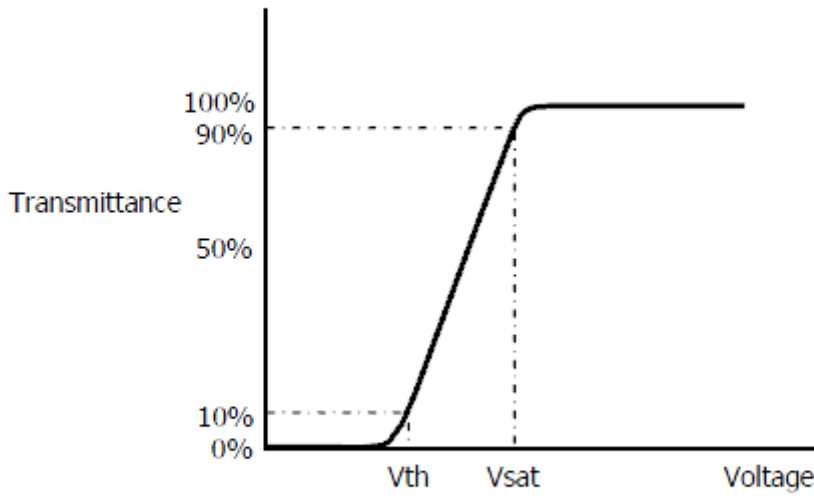
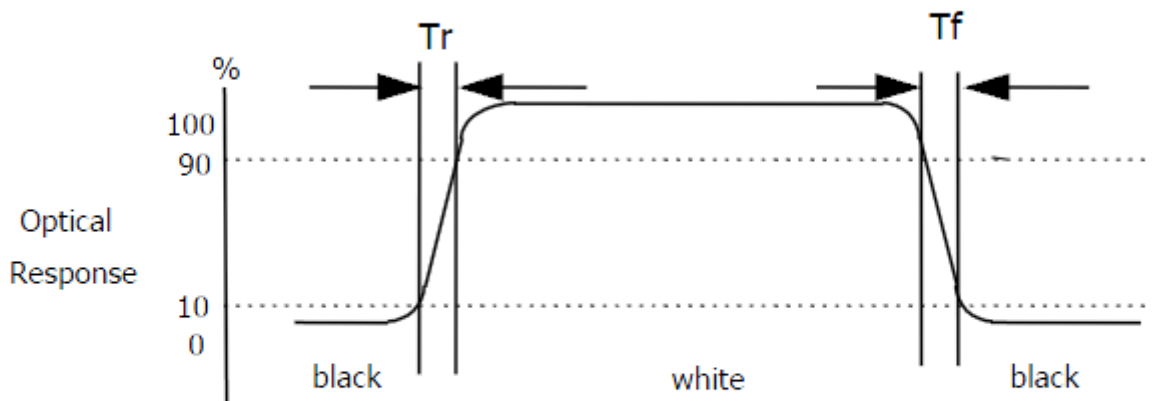


FIG. 3 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".



* Voltage conditions for Response time

- Vgate : 22V DC
- Vdata : 0V~4.5V DC
- Vcom : 0V (Ground)

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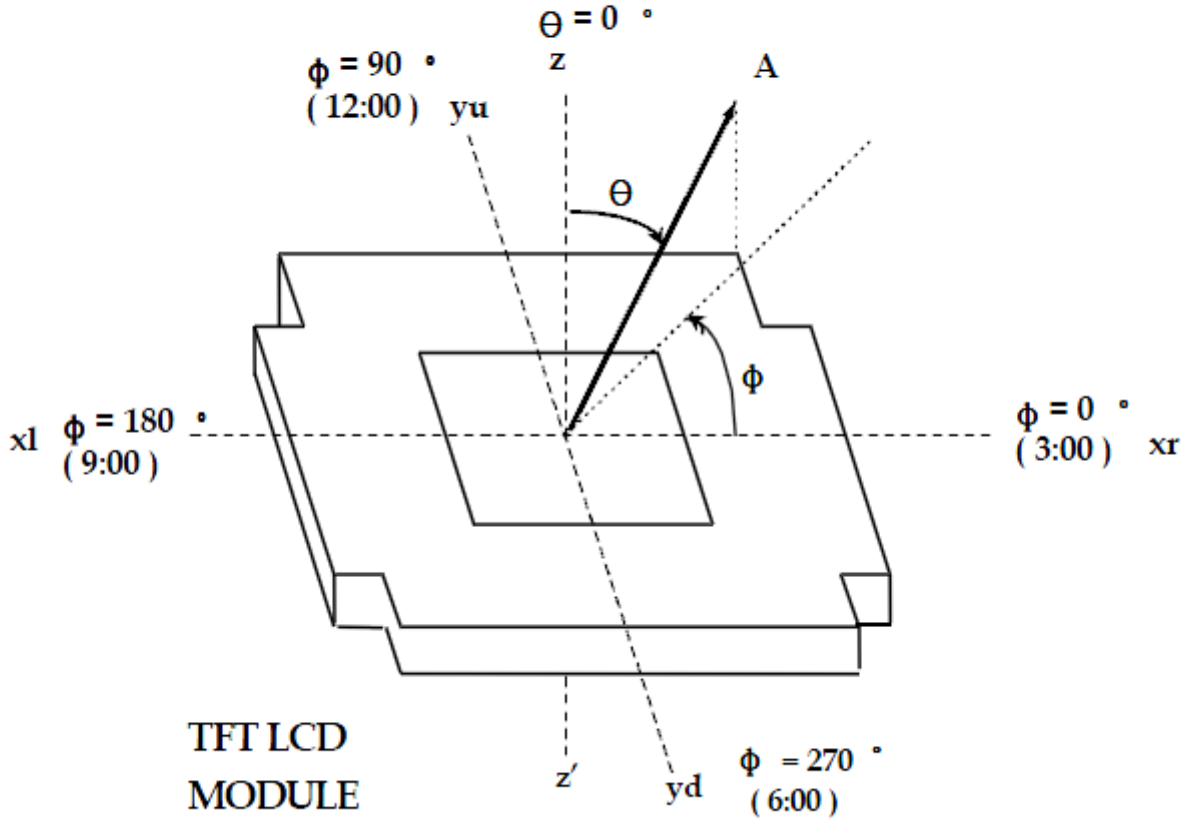
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FIG. 4 The definition of viewing angle

<dimension of viewing angle range>



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5. Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VCC	-0.3	4.6	V
Supply Voltage (Logic)	IOVCC	-0.3	4.6	
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	T _{ST}	-30	+80	°C

NOTE: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	VCC	2.5	3.3	3.6	V	
Supply Voltage (Logic)	IOVCC	1.65	1.8	3.3		
Normal mode Current consumption	IDD	--	9	--	mA	
Level input voltage	V _{IH}	0.7 IOVCC		IOVCC	V	
	V _{IL}	GND		0.3 IOVCC	V	
Level output voltage	V _{OH}	0.8 IOVCC		IOVCC	V	
	V _{OL}	GND		0.2 IOVCC	V	

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5.3 LED Backlight Characteristics

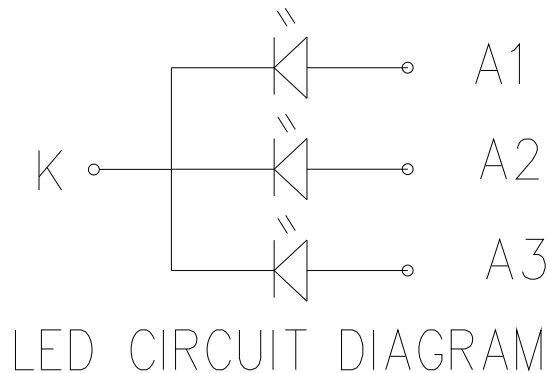
The back-light system is edge-lighting type with 3 chips White LED

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	45	60	--	mA	
Forward Voltage	V_F	--	3.2	--	V	
LCM Luminance	L_V		450	--	cd/m ²	Note3
LED life time	Hr	50000	--	--	Hour	Note1,2
Uniformity	AVg	80	--	--	%	Note3

SNote (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition:

$T_a=25\pm 3\text{ }^\circ\text{C}$, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at $T_a=25\text{ }^\circ\text{C}$ and $I_L=60\text{mA}$. The LED lifetime could be decreased if operating I_L is larger than 60mA. The constant current driving method is suggested.



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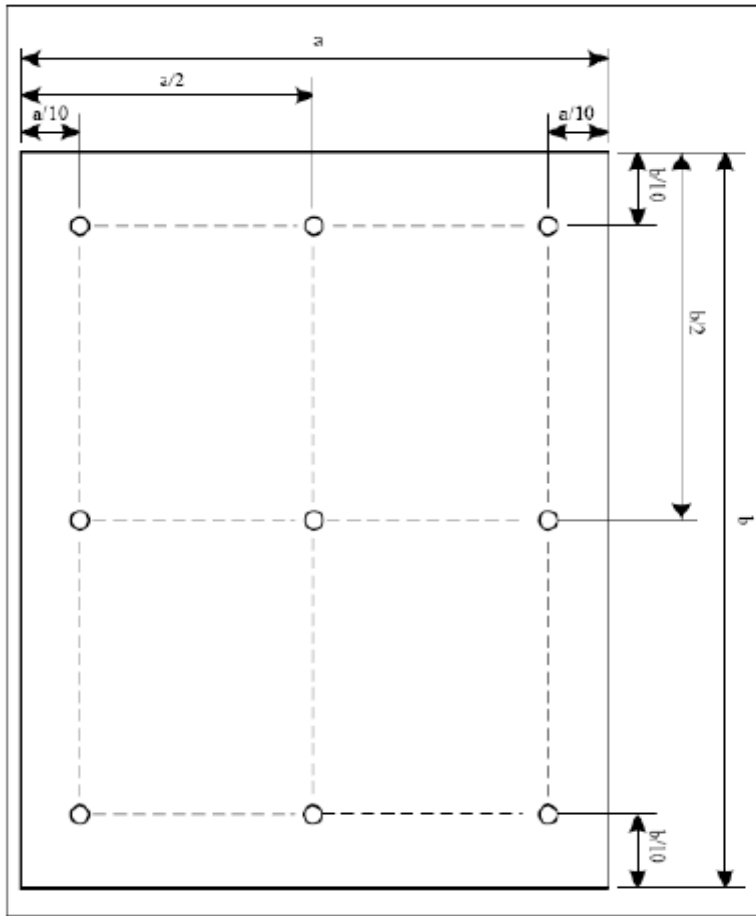
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NOTE 3: Luminance Uniformity of these 9 points is defined as below:



$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

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6. AC Characteristic

6.1 8080 Series MCU Parallel Interface Characteristics: 16/8-bit Bus

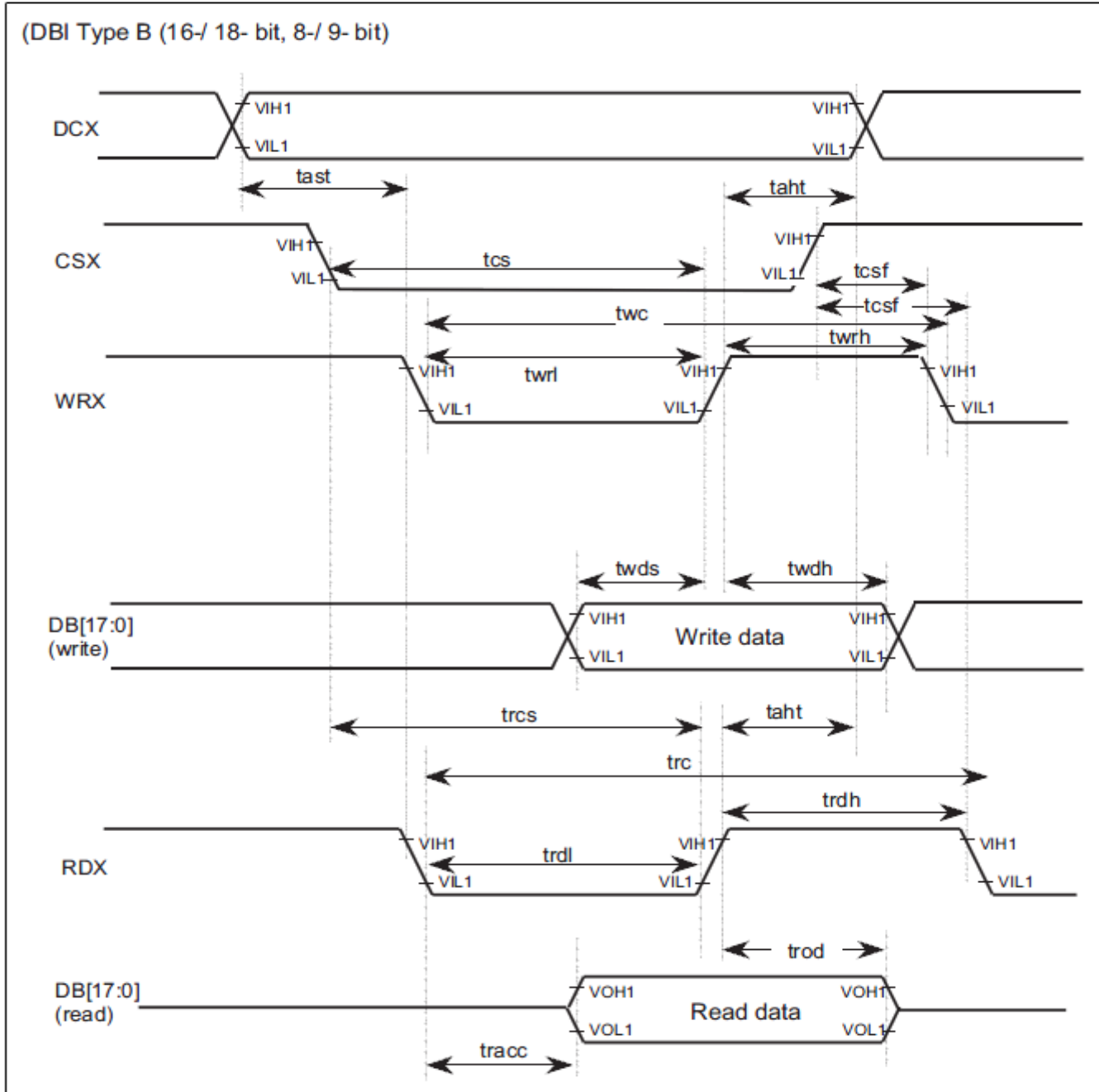


Figure A DBI Type B (16-/ 18- bit, 8-/9- bit timing) Bus Timing

Note 1: Logic High and Low levels of input signals are defined as follows:

RESX: IOVCC x 10%, 90%

Other than RESX: IOVCC x 20%, 80%

Note 2: Unused DB[17:0] pins shall be fixed at "IOVCC" or "GND".

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Item	Symbol	Unit	Test Condition	Min.	Max.
Address setup time	DCX	tast	ns	0	-
Address hold time (Write/Read)		taht	ns	10	-
Chip select setup time (Write)	CSX	tcs	ns	20	-
Chip select setup time (Read)		trcs	ns	170	-
Chip select wait time (Write/Read)		tcsf	ns	20	-
Write cycle time (Normal Write / High-speed write)	WRX	twc	ns	100/80	-
Write control pulse "High" period		twrh	ns	35	-
Write control pulse "Low" period		twrl	ns	35	-
Read cycle time	RDX	trc	ns	450	-
Read control pulse "High" period		trdh	ns	250	-
Read control pulse "Low" period		trdl	ns	170	-
Write data setup time	DB[17:0]	twds	ns	15	-
Write data hold time		twdh	ns	25	-
Read access time		tracc	ns	10	340
Output disable time		trod	ns	10	-
Rise / Fall time	-	tr/ff	ns	-	15



6.2 Reset Timing

Item	Symbol	Unit	Test Condition	Min.	Max.
Reset "Low" level width	tRW	us	Power On	10	—
Reset Time	tRT	ms		—	5

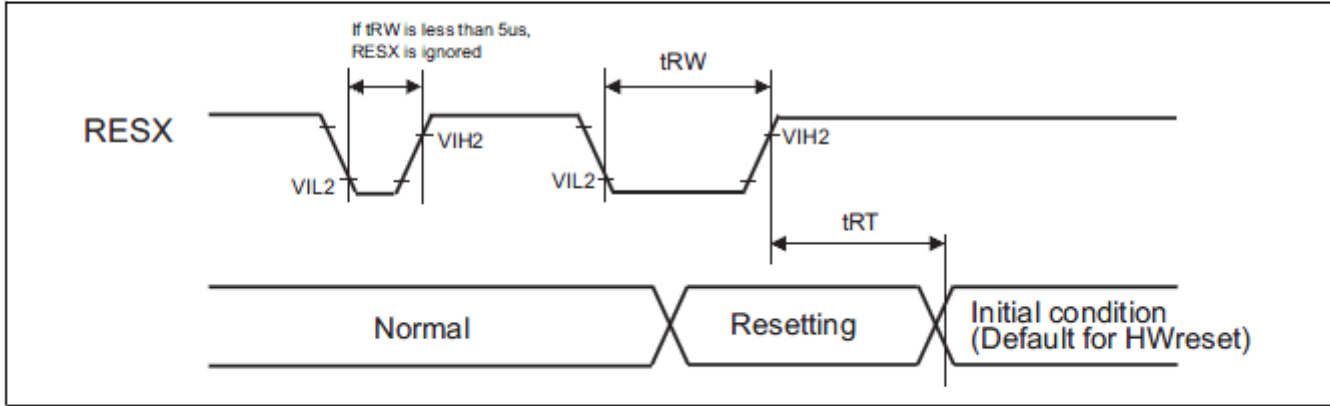


Figure D Reset Timing



7. LCD Module Out-Going Quality Level

7.1 VISUAL & FUNCTION INSPECTION STANDARD

7.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

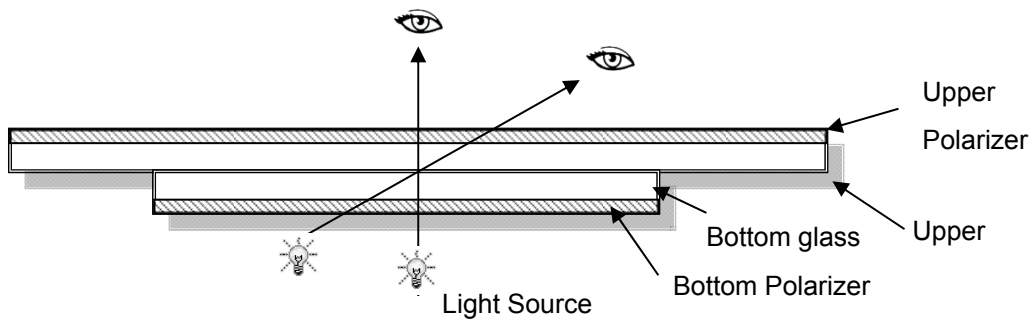
Temperature : 25±5℃

Humidity : 65%±10%RH

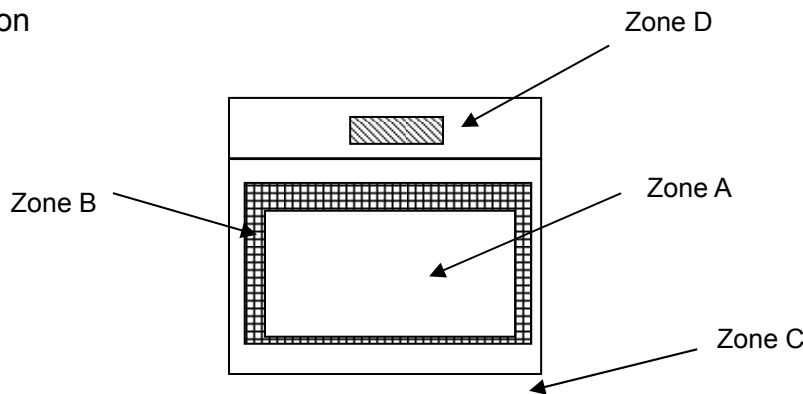
Viewing Angle : Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



7.1.2 Definition



Zone A : Effective Viewing Area(Character or Digit can be seen)

Zone B : Viewing Area except Zone A

Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer .)

Zone D : IC Bonding Area

Note:As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

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7.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class II

AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function	Major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Spot Line defect	Light dot, Dim spot, Polarizer Bubble ; Polarizer accidented spot.	
6	Soldering appearance	Good soldering , Peeling off is not allowed.	
7	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

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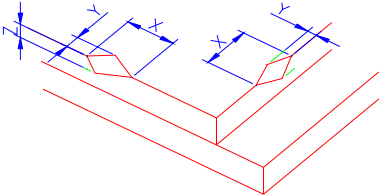
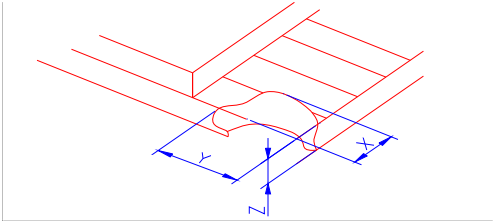
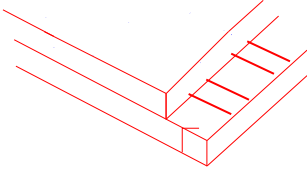
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7.1.4 Criteria (Visual)

Number	Items	Criteria(mm)						
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(1) The edge of LCD broken	 <table border="1" data-bbox="756 665 1453 813"> <tr> <td>X</td> <td>Y</td> <td>Z</td> </tr> <tr> <td>≤3.0mm</td> <td><Inner border line of the seal</td> <td>≤T</td> </tr> </table>	X	Y	Z	≤3.0mm	<Inner border line of the seal	≤T
X	Y	Z						
≤3.0mm	<Inner border line of the seal	≤T						
	(2)LCD corner broken	 <table border="1" data-bbox="834 1122 1374 1220"> <tr> <td>X</td> <td>Y</td> <td>Z</td> </tr> <tr> <td>≤3.0mm</td> <td>≤L</td> <td>≤T</td> </tr> </table>	X	Y	Z	≤3.0mm	≤L	≤T
X	Y	Z						
≤3.0mm	≤L	≤T						
	(3) LCD crack	 <p style="text-align: center;">Crack Not allowed</p>						





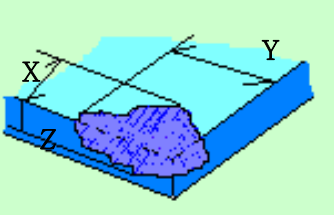
2.0	Spot defect	① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain)			
	<p>$\Phi=(X+Y)/2$</p>	Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.10$	Ignore		
		$0.10 < \Phi \leq 0.20$	3(distance $\geq 10\text{mm}$)		
	$0.20 < \Phi \leq 0.25$	2			
	$\Phi > 0.3$	0			
		② Dim spot (LCD/TP/Polarizer dim dot, light leakage, dark spot)			
		Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.1$	Ignore		
		$0.10 < \Phi \leq 0.20$	3(distance $\geq 10\text{mm}$)		
		$0.20 < \Phi \leq 0.25$	2		
		$\Phi > 0.3$	0		
		③ Polarizer accidented spot			
		Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.2$	Ignore		
		$0.3 < \Phi \leq 0.5$	2(distance $\geq 10\text{mm}$)		
		$\Phi > 0.5$	0		
		④ Pixel bad points (light dot, Dim dot, color dot)			
		Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.1$	Ignore		
		$0.15 < \Phi \leq 0.2$	2(distance $\geq 10\text{mm}$)		
		$\Phi > 0.2$	0		
		⑤ Polarizer Bubble			
		Zone	Acceptable Qty		
		Size (mm)	A	B	C
		$\Phi \leq 0.2$	Ignore		
		$0.3 < \Phi \leq 0.4$	3(distance $\geq 10\text{ m}$)		
		$0.4 < \Phi \leq 0.5$	2		
		$\Phi > 0.5$	0		



3.0	Line defect (LCD/TP /Polarizer backlight black/white line, scratch, stain)	Width(mm)	Length(m m)	Acceptable Qty		
				A	B	C
		$\Phi \leq 0.03$	Ignore	Ignore		
		$0.03 < W \leq 0.04$	$L \leq 3.0$	$N \leq 2$		
		$0.04 < W \leq 0.05$	$L \leq 2.0$	$N \leq 1$		
	$0.05 < W$	Define as spot defect				
4.0	Electronic Comp onents SMT	Not allow missing parts, solderless connection, cold solder joint, mis match, The positive and negative polarity opposite				
5.0	Display color& B rightness	<p>1. Color: Measuring the color coordinates, The measurement standar d according to the datasheet or samples.</p> <p>2. Brightness: Measuring the brightness of White screen, The measu rement standard according to the datasheet or Samples.</p>				

6.0	RTP Related	TP film bubble/ accidented spot	Size Φ (mm)	Acceptable Qty			
				A	B	C	
			$\Phi \leq 0.1$	Ignore			
			$0.1 < \Phi \leq 0.2$	3 (distance ≥ 10 mm)			
			$0.25 < \Phi \leq 0.3$	2			
			$\Phi > 0.3$	0			
		TP film scratch	Width(mm)	Length(mm)	Acceptable Qty		
					A	B	C
			$\Phi \leq 0.03$	Ignore	Ignore		
			$0.03 < W \leq 0.04$	$L \leq 3.0$	$N \leq 2$		
$0.04 < W \leq 0.05$	$L \leq 2.0$		$N \leq 1$				
	$0.05 < W$	Define as spot defect					



		<p>Assembly deflection</p>	<p>beyond the edge of backlight $\leq 0.2\text{mm}$</p>							
		<p>Bulge (undulation included)</p>	<p>The ITO film plumped below 0.40mm, it's ok.</p> 							
		<p>Newton Ring</p>	<p>Newton Ring area $> 1/3$ TP area NG</p> <p>Newton Ring area $\leq 1/3$ TP area OK</p>							
		<p>TP corner broken</p> <p>X : length</p> <p>Y : width</p> <p>Z : height</p>	<table border="1" data-bbox="710 1489 1141 1668"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>$X \leq 3\text{mm}$</td> <td>$Y \leq 3\text{mm}$</td> <td>$Z < \text{COVER thickness}$ s</td> </tr> </tbody> </table> <p>*Circuitry broken is not allowed.</p>	X	Y	Z	$X \leq 3\text{mm}$	$Y \leq 3\text{mm}$	$Z < \text{COVER thickness}$ s	
X	Y	Z								
$X \leq 3\text{mm}$	$Y \leq 3\text{mm}$	$Z < \text{COVER thickness}$ s								



		TP edge broken X : length Y : width Z : height	X	Y	Z	
			X≤4mm	Y≤2mm	Z<COVER thickness	
			* Circuitry broken is not allowed.			

Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed



8. Reliability Test Result

Item	Condition	Inspection after test
High Temperature Operating	70℃,96H	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1.Air bubble in the LCD; 2.Non-display; 3.Missing segments/line; 4.Glass crack; 5.Current IDD is twice higher than initial value.
Low Temperature Operating	-20℃, 96HR	
High Temperature Storage	80℃, 96HR	
Low Temperature Storage	-30℃, 96HR	
High Temperature & High Humidity Storage	+60℃, 90% RH ,96 hours.	
Thermal Shock (Non-operation)	-30℃,30 min ↔ 80℃,30 min, Change time:5min 20CYC.	
ESD test	C=150pF, R=330,5points/panel Air:±8KV, 5times; Contact:±6KV, 5 times; (Environment: 15℃~35℃, 30%~60%).	
Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces,80cm(MEDIUM BOX)	

Remark:

- 1.The test samples should be applied to only one test item.
- 2.Sample size for each test item is 5~10pcs.
- 3.For Damp Proof Test, Pure water(Resistance > 10MΩ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

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9. Cautions and Handling Precautions

9.1 Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.
Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.
If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.
- (14) Power supply should always be turned on/off by the item 6.1 Power On Sequence & 6.2 Power Off Sequence

9.2 Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.
It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

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10. Packing

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